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(54) Title: THREE-MOTORS CONFIGURATION FOR ADJUSTING WAFER TILT AND FOCUS

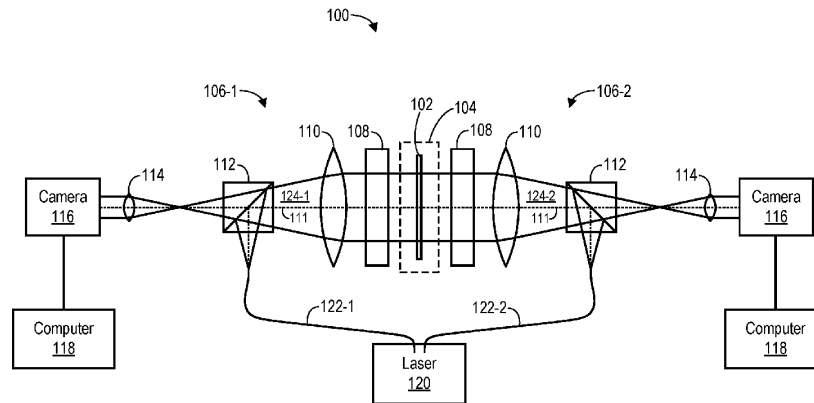


Figure 1

(57) Abstract: A system includes a first interferometer to measure the shape of a first side of a semiconductor wafer, a pallet to hold the semiconductor wafer and expose the first side of the semiconductor wafer to the first interferometer, and three motors coupled to the pallet. The three motors include a first motor coupled to the pallet at a first position, a second motor coupled to the pallet at a second position, and a third motor coupled to the pallet at a third position.

[Continued on next page]

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